



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: L-1387QMP/1CGKQBDW

Green
Blue

Features

- Surface mount type.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Package: 1000pcs / reel.
- Moisture sensitivity level : level 3.
- Housing material: PPA.
- Housing UL rating : 94V-0.
- High temperature resistant housing.
- High glass transition temperature epoxy.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

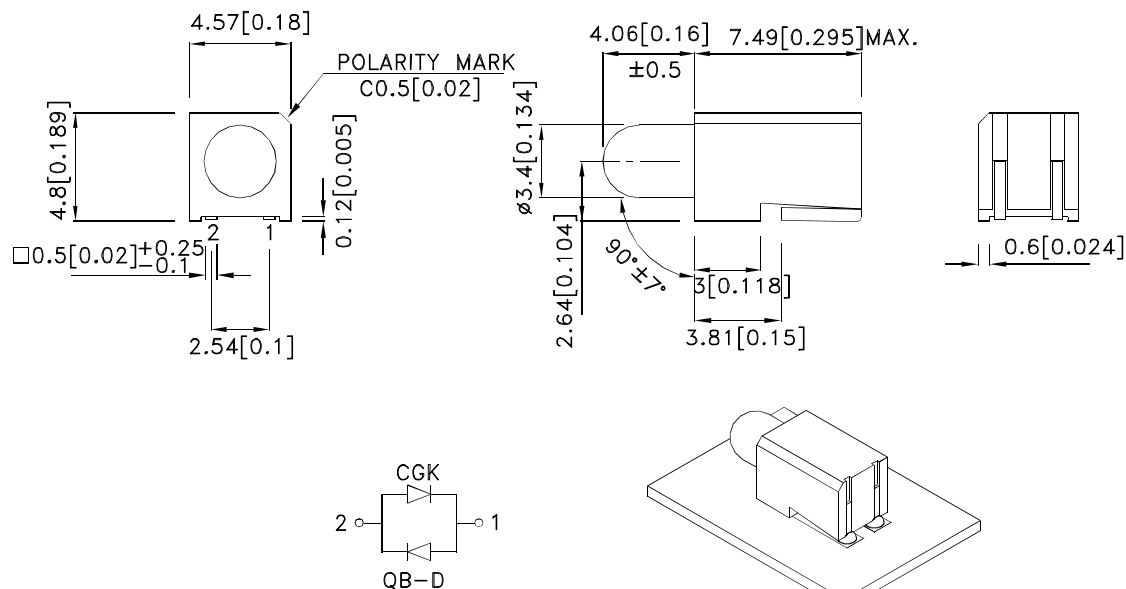
The Blue source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
L-1387QMP/1CGKQBDW	Green (AlGaInP)	White Diffused	50	120	60°
	Blue (InGaN)		60	130	

Notes:

1. $\theta_{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green Blue	574 460		nm	I _F =20mA
λ_D [1]	Dominant Wavelength	Green Blue	570 465		nm	I _F =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green Blue	20 25		nm	I _F =20mA
C	Capacitance	Green Blue	15 100		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Green Blue	2.1 3.3	2.5 4	V	I _F =20mA

Notes:

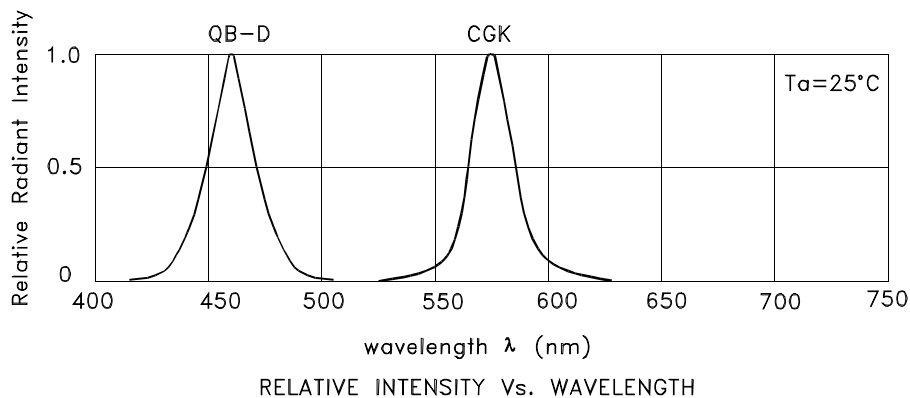
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

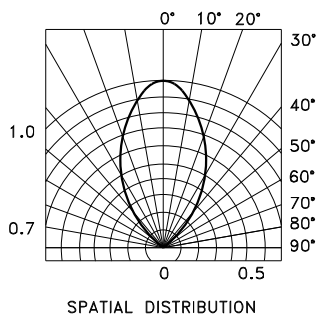
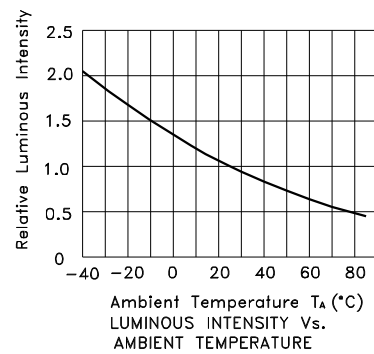
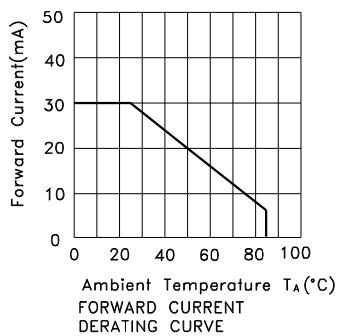
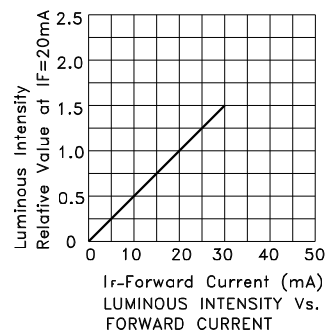
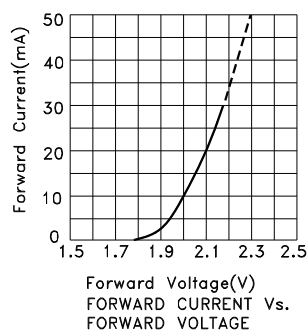
Parameter	Green	Blue	Units
Power dissipation	75	120	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	150	150	mA
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:

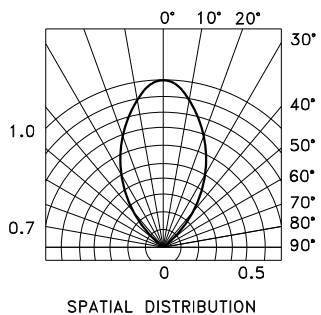
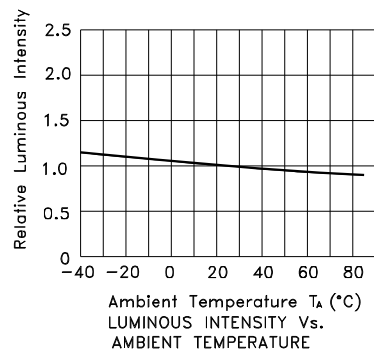
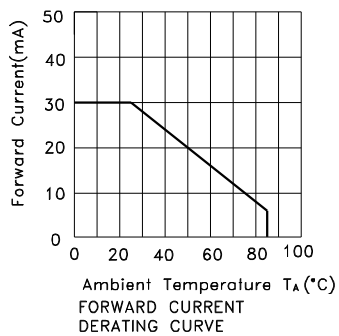
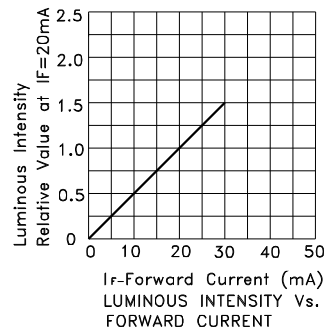
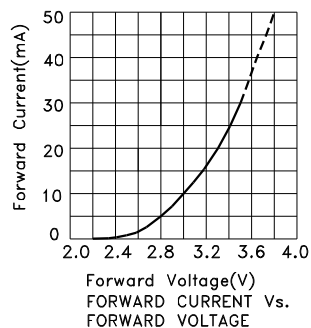
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



L-1387QMP/1CGKQBDW Green

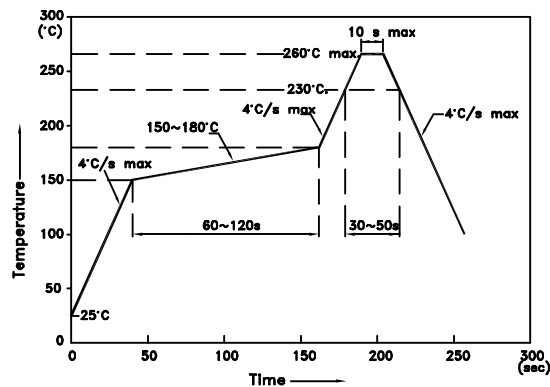


Blue



L-1387QMP/1CGKQBDW

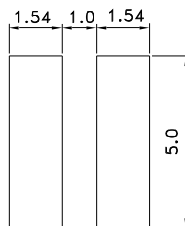
Reflow Soldering Profile For Lead-free SMT Process.



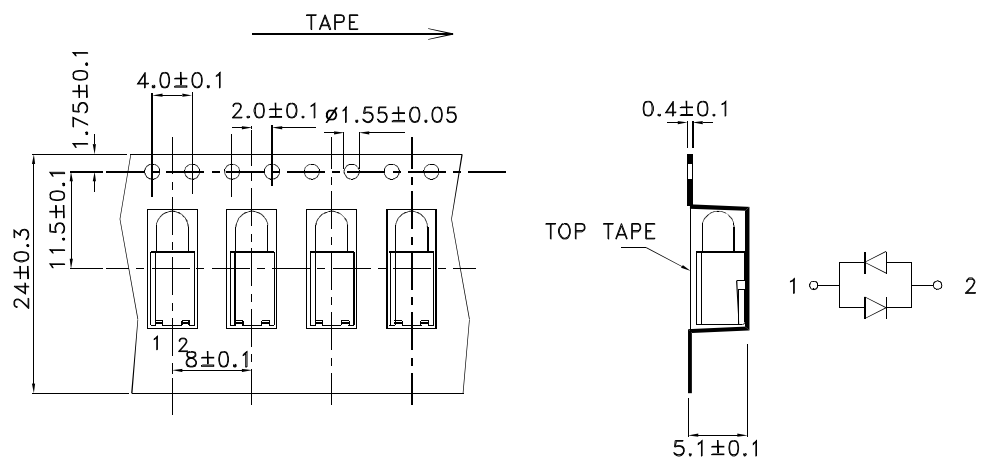
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. No more than once.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

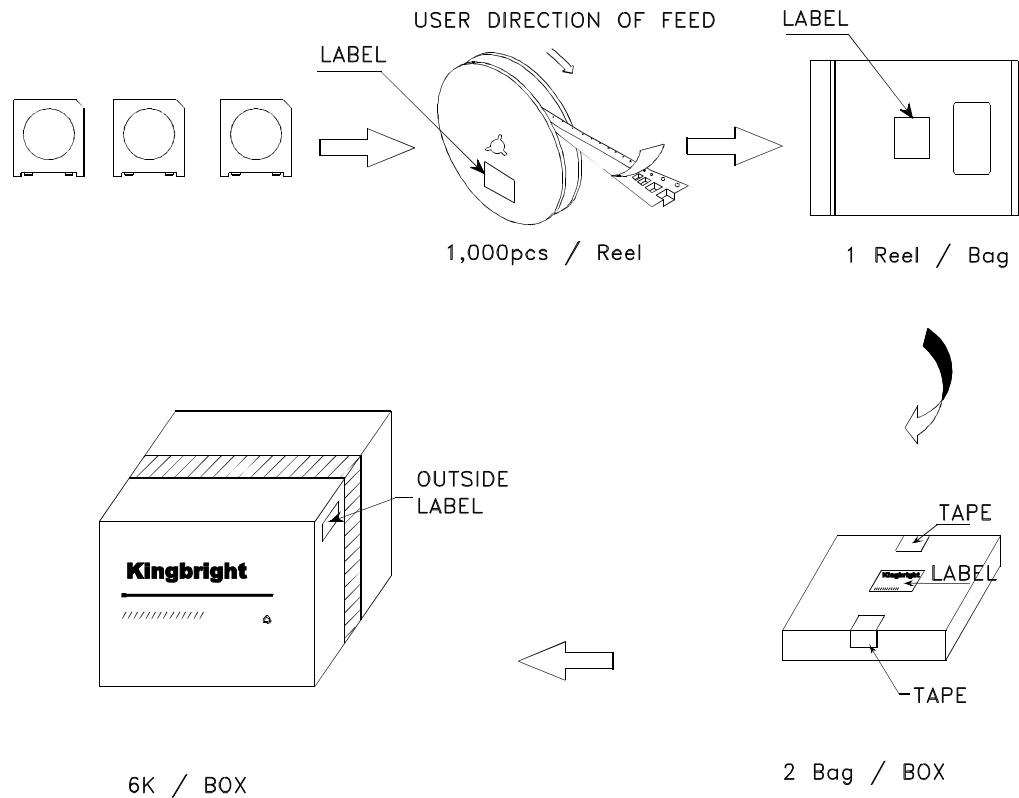



Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS

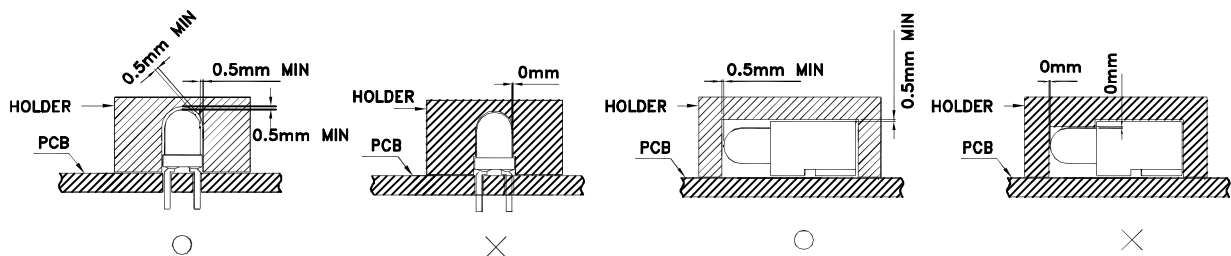
L-1387QMP/1CGKQBDW



Kingbright							
P/NO: L-1387QMPxxx							
QTY: 1000 pcs	Q.C. <table border="1"><tr><td>Q</td><td>C</td></tr><tr><td>XX</td><td>XX XX</td></tr><tr><td colspan="2">PASSED</td></tr></table>	Q	C	XX	XX XX	PASSED	
Q	C						
XX	XX XX						
PASSED							
S/N: XXXX							
CODE: XXX							
LOT NO:							
 xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx							
RoHS Compliant							

PRECAUTIONS

1. A moisture barrier bag (MBB) containing LEDs shall be kept in an environment with temperature below 40°C and humidity below 90% RH. A MBB shall be kept sealed until the LEDs contained in that bag are to be used immediately. Storage in an environment with temperature 5~30°C and humidity below 60% RH.
2. After a MBB has been opened, all LEDs contained in that bag shall complete soldering process within according to the conditions listed on the Kingbright MBB.
3. If the 10% spot of a humidity indicator card (HIC) indicates wet, LEDs shall be baked according to the conditions listed on the Kingbright MBB.
4. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



5. The tip of the soldering iron should never touch the lens epoxy.
6. After soldering, allow at least three minutes for the component to cool to room temperature before further operations.
7. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.

Detailed application notes are listed on our website.

http://www.kingbright.com/application_notes